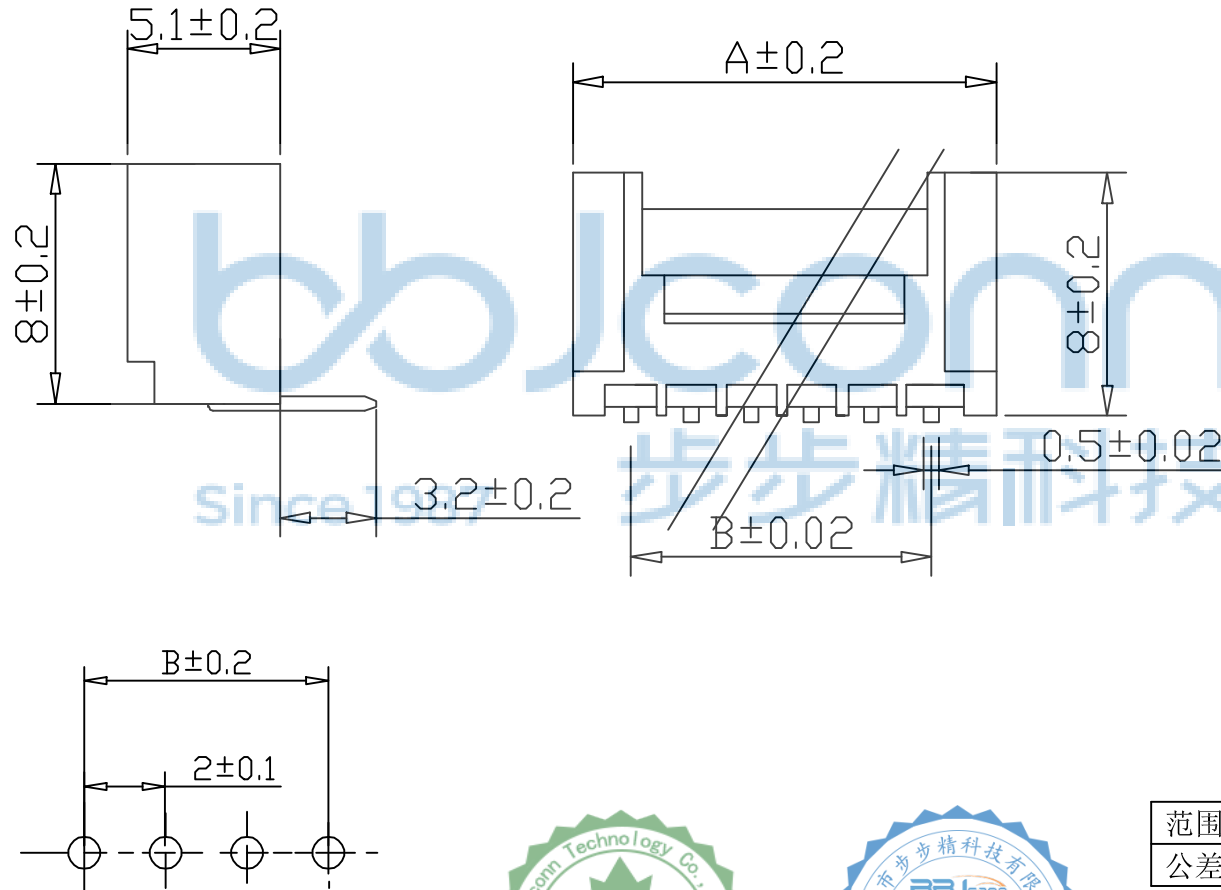


REV.	ECN NO	CONTENT	DATE	ENGINEER
A0				

使用温度范围 (Ambient temperature Range): $-25^{\circ} \sim +85^{\circ}$
适用基板厚度 (Applicable PCboard thickness): $0.8\text{mm} \sim 1.6\text{mm}$
额定电压 (Voltage rating): 250V AC, DC
额定电流 (Current rating): 2A
接触电阻 (Contact Resistance): $\leq 0.01\Omega$
绝缘电阻 (Insulation Resistance): $\geq 1000\text{M}\Omega$
耐压 (Withstand Voltage): 800V/min
材料 (Material)
1. 基座: PA66 FV2
2. 插针: 黄铜



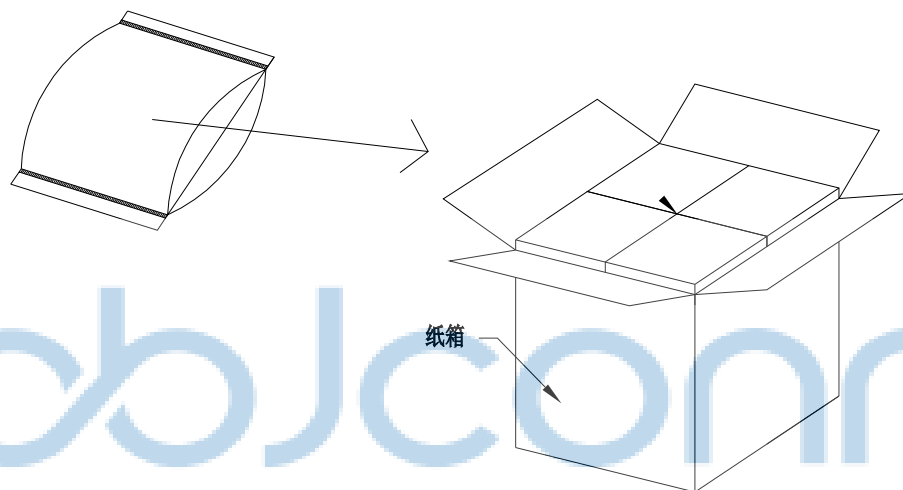
孔位	A	B
2	6.0	2.0
3	8.0	4.0
4	10.0	6.0
5	12.0	8.0
6	14.0	10.0
7	16.0	12.0
8	18.0	14.0
9	20.0	16.0
10	22.0	18.0
11	24.0	20.0
12	26.0	22.0
13	28.0	24.0
14	30.0	26.0
15	32.0	28.0

范围	>0-3	>3-18	>18-50	>50-100
公差	±0.15	±0.2	±0.3	±0.5



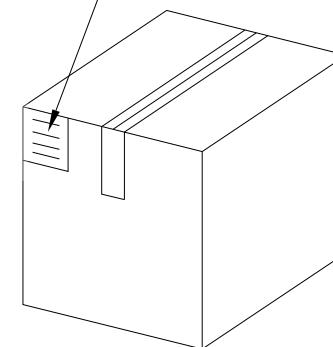
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PDWG.NO: 0102-1	DR. SGF	NAME: HY-5AW (2.0-5P) 弯针 带扣 红色	
APPD. JM_Zheng	CHKD. LYX	PJ. NO.: WT.01.23-21-1001	
		SIZE: A4	DRW NO.:
		FINISH: SEE NOTES	MAT'L.: SEE NOTES
		SCALE: N/A	REV.: A0
		UNIT: mm	PAGE: 1/2

PE袋规格:***X*** (以实际出货为准)



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成品标签



1. 包装要求:

- 1.1 每PE袋包装 2000pcs;
- 1.2 每1袋放一小纸盒;
- 1.3 每20个小纸盒放一个纸箱, 共计40000PCS
- 1.4 纸箱外贴上标签



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.X: ±0.38 .XX: ±0.25 .XXX: ±0.13		NAME: HY-5AW (2.0-5P) 弯针 带扣 红色	
APPD. JM_Zheng		PJ. NO.: WT.01.23-21-1001	
CHKD. LYX		SIZE: A4 DRW NO.:	
PDWG.NO: 0102-1		FINISH: SEE NOTES MAT'L.: SEE NOTES	
DR. SGF		SCALE: N/A REV.: A0 UNIT: mm PAGE: 2/2	